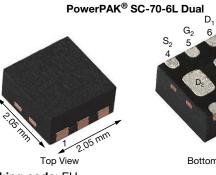
SiA533EDJ

Vishay Siliconix

N- and P-Channel 12 V (D-S) MOSFET



www.vishay.com

Marking code: EH

G.

 D_2 Bottom View

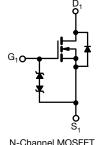
PRODUCT SUMMARY N-CHANNEL P-CHANNEL V_{DS} (V) 12 -12 $\mathsf{R}_{\mathsf{DS}(\mathsf{on})}$ (Ω) at V_{GS} = ± 4.5 V 0.034 0.059 $\mathsf{R}_{\mathsf{DS}(\mathsf{on})}$ (Ω) at V_{GS} = ± 2.5 V 0.040 0.081 $R_{DS(on)}(\Omega)$ at $V_{GS} = \pm 1.8 V$ 0.050 0.115 $R_{DS(on)}(\Omega)$ at $V_{GS} = \pm 1.5 V$ 0.070 0.215 Q_g typ. (nC) 5.6 7.8 I_D (A) a 4.5 -4.5 Configuration N- and p-pair

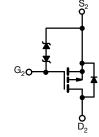
FEATURES

- TrenchFET[®] power MOSFETs
- Typical ESD protection: n-channel 1500 V, p-channel 1000 V
- 100 % R_g tested
- FREE • Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Load switch for portable devices
- DC/DC converters





N-Channel MOSFET

P-Channel	MOSFET

ORDERING INFORMATION					
Package	PowerPAK SC-70				
Lead (Pb)-free and halogen-free	SiA533EDJ-T1-GE3				

PARAMETER	SYMBOL	N-CHANNEL	P-CHANNEL	UNIT		
Drain-source voltage	V _{DS}	12	-12	V		
Gate-source voltage	V _{GS}	± 8	± 8	v		
	T _C = 25 °C		4.5 ^a	-4.5 ^a		
Continuous drain surrant (T 150 °C)	T _C = 70 °C	I _D	4.5 ^a	-4.5 ^a		
Continuous drain current (T _J = 150 °C)	T _A = 25 °C		4.5 ^{a, b, c}	-4.5 ^{a, b, c}		
	T _A = 70 °C		4.5 ^{a, b, c}	-3.7 ^b ,c	А	
Pulsed drain current	I _{DM}	20	-15			
	T _C = 25 °C		4.5 ^a	-4.5 ^a		
Source-drain current diode current	T _A = 25 °C	۱ _S	1.6 ^{b, c}	-1.6 ^{b, c}		
Maximum power dissipation	T _C = 25 °C		7.8	7.8		
	T _C = 70 °C		5	5	14/	
	T _A = 25 °C	P _D	1.9 ^{b, c}	1.9 ^{b, c}	W	
	T _A = 70 °C	1	1.2 ^{b, c}	1.2 ^{b, c}		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150			
Soldering recommendations (peak temperature) ^{d, e}			20	60	°C	

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THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	N-CHANNEL		P-CHANNEL		UNIT	
		STWDOL	TYP.	MAX.	TYP.	MAX.	ONIT	
Maximum junction-to-ambient ^{b, f}	t ≤ 5 s	R _{thJA}	52	65	52	65	°C/W	
Maximum junction-to-case (drain)	Steady state	R _{thJC}	12.5	16	12.5	16	0/11	

Notes

a. Package limited

b. Surface mounted on 1" x 1" FR4 board

c. t = 5 s

d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

f. Maximum under steady state conditions is 110 °C/W

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static				I	<u> </u>		I	
		$V_{GS} = 0 V, I_D = 250 \mu A$	N-Ch	12	-	-		
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	P-Ch	-12	-	-	V	
V tomperature coefficient		I _D = 250 μA	N-Ch	-	19	-		
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	I _D = -250 μA	P-Ch	-	-5.7	-		
V temperature coefficient		I _D = 250 μA	N-Ch	-	-2.7	-	- mV/°C	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μA	P-Ch	-	1.7	-		
Cata threshold voltage	N/	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	N-Ch	0.4	-	1	- V - μΑ	
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	P-Ch	-0.4	-	-1		
		$V_{DS}=0~V,~V_{GS}=\pm~4.5~V$	N-Ch	-	-	± 0.5		
Cata hady laakaga			P-Ch	-	-	± 0.5		
Gate-body leakage	I _{GSS}	V_{DS} = 0 V, V_{GS} = ± 8 V	N-Ch	-	-	± 5		
			P-Ch	-	-	± 5		
		$V_{DS} = 12 \text{ V}, V_{GS} = 0 \text{ V}$	N-Ch	-	-	1		
Zero gate voltage drain current		$V_{DS} = -12 V, V_{GS} = 0 V$	P-Ch	-	-	-1		
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 12 \text{ V}, V_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	N-Ch	-	-	10		
		V_{DS} = -12 V, V_{GS} = 0 V, T_{J} = 55 °C	P-Ch	-	-	-10		
On-state drain current ^b	1	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}$	N-Ch	10	-	-	^	
On-state drain current ~	I _{D(on)}	$V_{DS} \leq$ -5 V, V_{GS} = -4.5 V	P-Ch	-10	-	-	A	
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 4.6 \text{ A}$	N-Ch	-	0.028	0.034	Ω	
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -3.6 \text{ A}$	P-Ch	-	0.048	0.059		
		$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 4.2 \text{ A}$	N-Ch	-	0.032	0.040		
Drain-source on-state resistance b		$V_{GS} = -2.5 \text{ V}, \text{ I}_{D} = -3.1 \text{ A}$	P-Ch	-	0.066	0.081		
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 1.8 \text{ V}, \text{ I}_{D} = 3.8 \text{ A}$	N-Ch	-	0.038	0.050		
	Γ Γ	$V_{GS} = -1.8 \text{ V}, \text{ I}_{D} = -2.6 \text{ A}$	P-Ch	-	0.093	0.115		
	Γ Γ	$V_{GS} = 1.5 \text{ V}, \text{ I}_{D} = 1.5 \text{ A}$	N-Ch	-	0.045	0.070		
	F F	$V_{GS} = -1.5 \text{ V}, \text{ I}_{D} = -0.5 \text{ A}$	P-Ch	-	0.120	0.215		
Forward transpoorductors b		$V_{DS} = 6 V, I_{D} = 4.6 A$	N-Ch	-	21	-	6	
Forward transconductance ^b	9fs	V _{DS} = -6 V, I _D = -3.6 A	P-Ch	-	11	-	S	

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Dynamic ^a					1	1	
			N-Ch	-	420	-	
Input capacitance	C _{iss}	N-channel	P-Ch	-	545	-	
Output consolitones	C	$V_{DS} = 6 V, V_{GS} = 0 V, f = 1 MHz$	N-Ch	-	100	-	~F
Output capacitance	C _{oss}	P-channel	P-Ch	-	192	-	pF
Reverse transfer capacitance	C _{rss}	$V_{DS} = -6 V, V_{GS} = 0 V, f = 1 MHz$	N-Ch	-	62	-	
	Orss		P-Ch	-	175	-	
		$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 5.9 \text{ A}$	N-Ch	-	10	15	
Total gate charge	Qg	$V_{DS} = -10 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -4.7 \text{ A}$	P-Ch	-	13	20	
5 5	9	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 5.9 \text{ A}$	N-Ch	-	5.6	8.5	
		$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -4.7 \text{ A}$	P-Ch	-	7.8	12	nC
Gate-source charge	Q _{gs}	N-channel $V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 5.9 \text{ A}$	N-Ch P-Ch	-	0.7	-	
		$v_{DS} = 10^{\circ} v_{1}^{\circ} v_{GS} = 4.0^{\circ} v_{1}^{\circ} I_{D} = 0.0^{\circ} v_{1}^{\circ}$	N-Ch	-	1.3 0.85	-	-
Gate-drain charge	Q _{gd}	P-channel				-	4
		$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -4.7 \text{ A}$	P-Ch	-	2.3	-	<u> </u>
Gate resistance	Rg	f = 1 MHz	N-Ch	0.7	3.5	7	Ω
			P-Ch N-Ch	1.4 -	7 10	14 15	
Furn-on delay time	t _{d(on)} t _r	N-channel V_{DD} = 6 V, R _L = 1.3 Ω , I _D \cong 4.8 A, V _{GEN} = 4.5 V, R _a = 1 Ω	P-Ch	-	10	25	- ns
			N-Ch	-	10	15	
Rise time Turn-off delay time Fall time			P-Ch	-	15	25	
	t _{d(off)} t _f		N-Ch	-	20	30	
		P-channel V _{DD} = -6 V, R _L = 1.6 Ω,	P-Ch	-	25	40	
		$I_D \cong -3.7 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_q = 1 \Omega$	N-Ch	-	10	15	
			P-Ch	-	10	15	
		N-channel	N-Ch	-	5	10	
Turn-on delay time	t _{d(on)}		P-Ch	-	5	10	
	+	$V_{DD} = 6 V, R_L = 1.3 \Omega,$	N-Ch	-	10	15	
Rise time	t _r	$I_D \cong 4.8 \text{ A}, V_{GEN} = 8 \text{ V}, \text{ R}_g = 1 \Omega$	P-Ch	-	10	15	
Turn-off delay time	t _{d(off)}	P-channel	N-Ch	-	20	30	
	•а(оп)	$V_{DD} = -6 V, R_L = 1.6 \Omega,$	P-Ch	-	25	40	
Fall Time	t _f	$I_D \cong$ -3.7 A, V_{GEN} = -8 V, R_g = 1 Ω	N-Ch	-	10	15	_
			P-Ch	-	10	15	
Drain-Source Body Diode Characteristi	cs		N Ob			4.5	
Continuous source-drain diode current	Is	T _C = 25 °C	N-Ch P-Ch	-	-	4.5 -4.5	
			N-Ch	-	-	-4.5 20	A
Pulse diode forward current ^a	I _{SM}		P-Ch	-	-	-15	1
	1	I _S = 4.8 A, V _{GS} = 0 V	N-Ch	-	0.85	1.2	
Body diode voltage	V _{SD}	$I_{\rm S} = -3.7$ A, $V_{\rm GS} = 0$ V	P-Ch	-	-0.87	-1.2	V
	1.		N-Ch	-	10	20	
Body diode reverse recovery time	t _{rr}	N-channel	P-Ch	-	25	50	ns
Dedu diede veveree versterverte	<u> </u>	I _F = 4.4 A, di/dt = 100 A/µs,	N-Ch	-	5	10	
Body diode reverse recovery charge	Q _{rr}	T _J = 25 °C	P-Ch	-	10	20	nC
Powerse receivery fall time	+	P-channel	N-Ch	-	5.5	-	
Reverse recovery fall time	t _a	I _F = -3.7 A, di/dt = -100 A/μs,	P-Ch	-	17	-	
Reverse recovery risc time	+	T _J = 25 °C	N-Ch	-	4.5	-	ns
Reverse recovery rise time	t _b		P-Ch	-	8	-]

Notes

Downloaded from Arrow.com.

a. Guaranteed by design, not subject to production testing

b. Pulse test; pulse width \leq 300 $\mu s,\,duty\,cycle \leq 2\,$ %

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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3

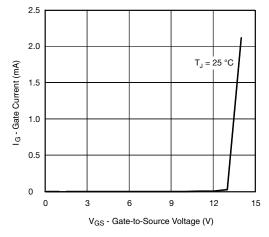
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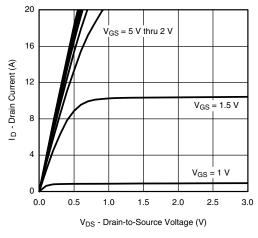
SiA533EDJ

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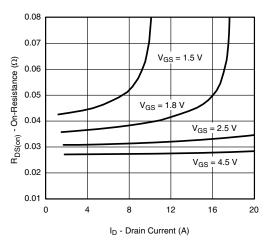
N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



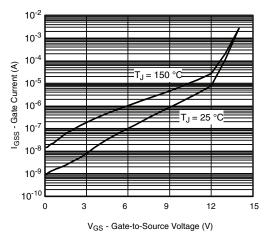
Gate Current vs. Gate-Source Voltage



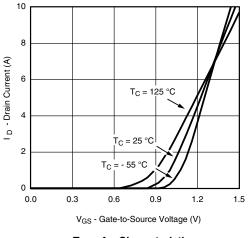




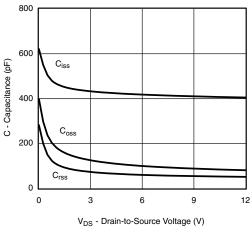
On-Resistance vs. Drain Current and Gate Voltage



Gate Current vs. Gate-Source Voltage







Capacitance

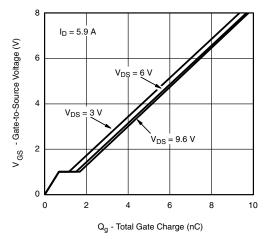
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4 For technical questions, contact: <u>pmostechsupport@vishay.com</u> Document Number: 65706

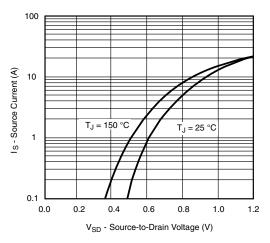
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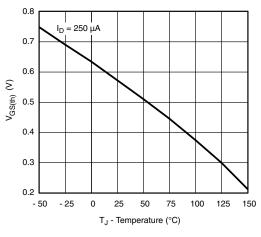
N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



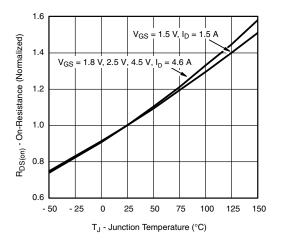
Gate Charge



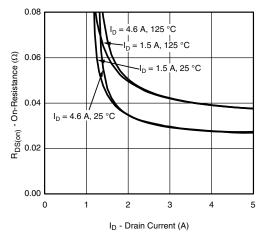
Source-Drain Diode Forward Voltage



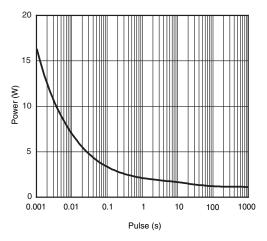
Threshold Voltage



On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power (Junction-to-Ambient)

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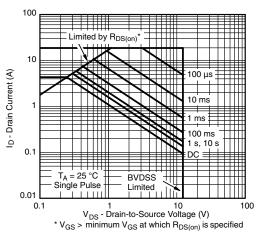
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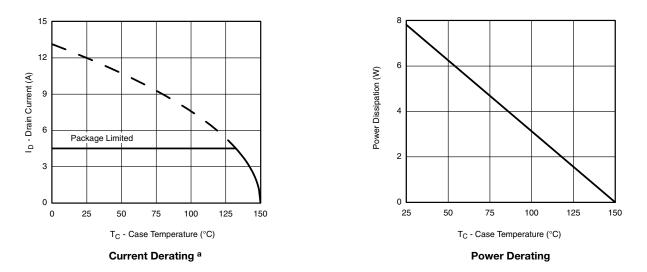
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N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Safe Operating Area, Junction-to-Ambient

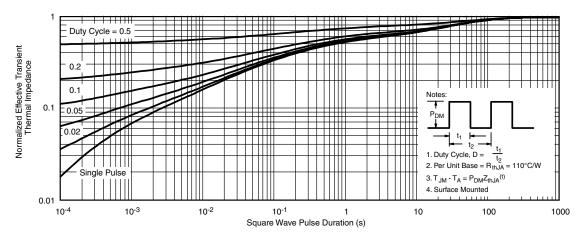


Note

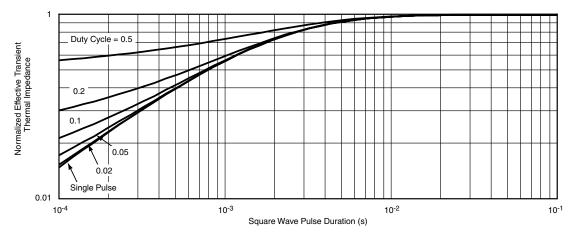
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



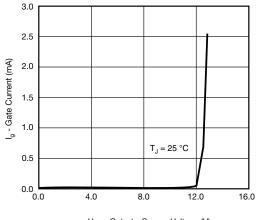
Normalized Thermal Transient Impedance, Junction-to-Case



SiA533EDJ

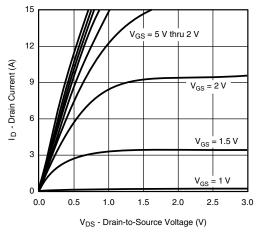
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P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

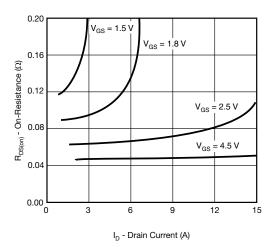


 $\rm V_{GS}$ - Gate-to-Source Voltage (V)

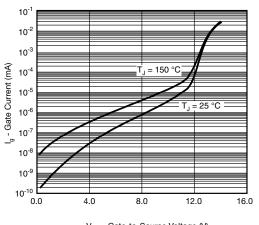
Gate Current vs. Gate-Source Voltage





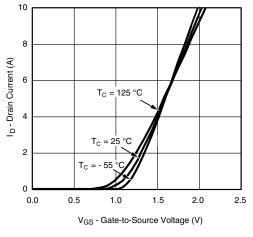


On-Resistance vs. Drain Current and Gate Voltage

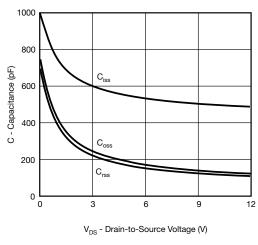


V_{GS} - Gate-to-Source Voltage (V)

Gate Current vs. Gate-Source Voltage



Transfer Characteristics





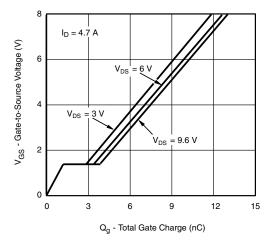
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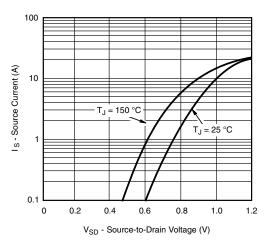
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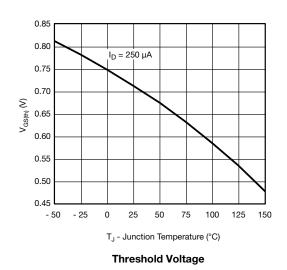
P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

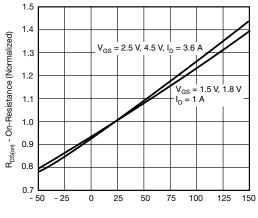


Gate Charge



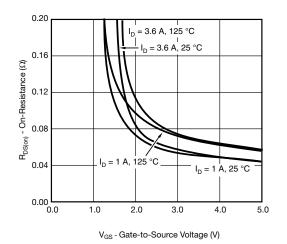
Source-Drain Diode Forward Voltage



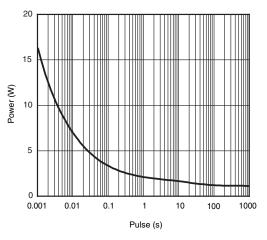


T_J - Junction Temperature (°C)

On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power (Junction-to-Ambient)

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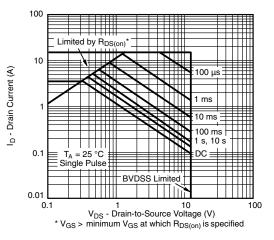
9

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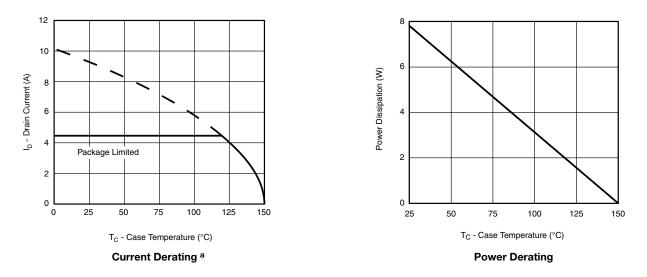
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P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Safe Operating Area, Junction-to-Ambient

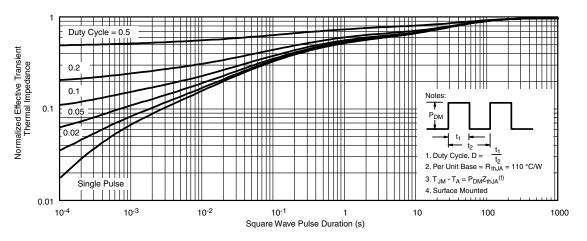


Note

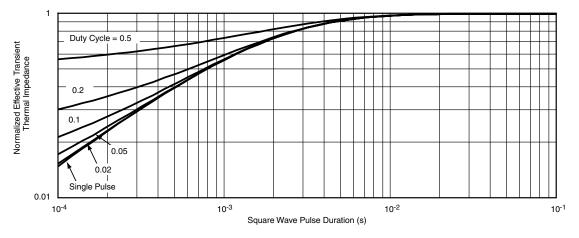
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P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



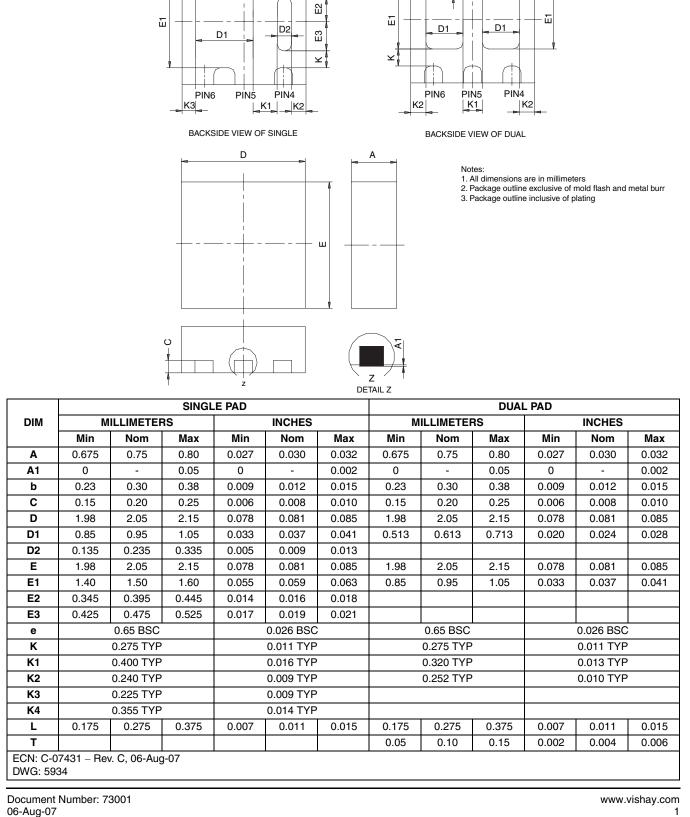
Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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S10-0214-Rev. A, 25-Jan-10	11	Document Number: 65706			
For tech	nnical questions, contact: <u>pmostechsupport@vishay.com</u>	<u>1</u>			
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Package Information

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Vishay Siliconix

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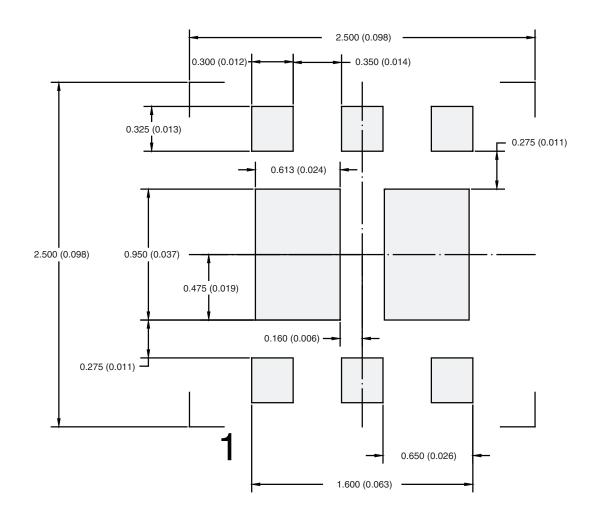
PowerPAK[®] SC70-6L

Application Note 826

Vishay Siliconix



RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Dual



Dimensions in mm (inches)



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